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Fairchild Semiconductor FQI27N25TU_F085

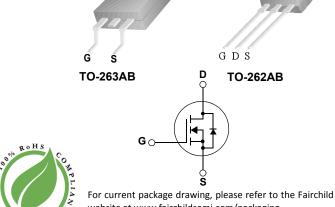
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■ UIS Capability ■ RoHS Compliant ■ Qualified to AEC Q101

- **Applications** ■ Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12V Systems



website at www.fairchildsemi.com/packaging

MOSFET Maximum Ratings T_J = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V_{DSS}	Drain to Source Voltage		250	V
V_{GS}	Gate to Source Voltage		±30	V
	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C = 25°C	25.5	А
ID	Pulsed Drain Current	T _C = 25°C	See Figure 4	A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	972	mJ
D	Power Dissipation		417	W
P_D	Derate above 25°C		3.3	W/°C
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 150	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.3	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	43	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FQB27N25TM	FQB27N25TM_F085	TO-263AB	330mm	24mm	800 units	
FQI27N25TU	FQI27N25TU F085	TO-262AB	Tube	N/A	50 units	

- 1: Current is limited by bondwire configuration.
- 2: Starting $T_J = 25^{\circ}C$, L = 4.67mH, $I_{AS} = 20.4$ A, $V_{DD} = 100$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3: R_{θ,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θ,JC} is guaranteed by design while R_{θ,JA} determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Test Conditions

Min.

Тур.

Max.

Units



Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted.

Parameter

Off Characteristics								
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, \	/ _{GS} = 0V	250	-	-	V	
1	Drain to Source Leakage Current	V _{DS} =250V,	$T_J = 25^{\circ}C$	-	-	1	μΑ	
DSS	Drain to Source Leakage Current	$V_{GS} = 0V$	$T_J = 150^{\circ}C(Note 4)$	-	-	250	uA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 30V$		-	-	±100	nA	

On Characteristics

Symbol

	V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		3.0	4.1	5.0	V
	R _{DS(on)} Drain to Source On Resistance	Drain to Source On Registence	I _D = 25.5A,	$T_J = 25^{\circ}C$	-	108	131	$m\Omega$
		V _{GS} = 10V	$T_J = 150^{\circ}C(Note 4)$	-	265	310	mΩ	

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	1800	-	pF
C _{oss}	Output Capacitance			-	350	-	pF
C _{rss}	Reverse Transfer Capacitance			-	45	-	pF
R_g	Gate Resistance	f = 1MHz		-	0.82	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	V _{GS} = 0 to 10V	V _{DD} = 125V	-	45	49	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0$ to $2V$	I _D = 27A	-	3.3	4	nC
Q _{gs}	Gate to Source Gate Charge		-	-	12	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			-	23	-	nC

Switching Characteristics

t _{on}	Turn-On Time		-	-	196	ns
t _{d(on)}	Turn-On Delay		-	36	-	ns
t _r	Rise Time	V _{DD} = 125V, I _D = 27A,	-	122	-	ns
t _{d(off)}	Turn-Off Delay	V_{GS} = 10V, R_{GEN} = 25 Ω	-	81	-	ns
t _f	Fall Time		-	60	-	ns
t _{off}	Turn-Off Time		-	-	164	ns

Drain-Source Diode Characteristics

V _{SD} Sou	Source to Drain Diode Voltage	$I_{SD} = 25.5A, V_{GS} = 0V$	-	-	1.5	V
	Source to Drain blode voltage	$I_{SD} = 12.75A, V_{GS} = 0V$	-	-	1.25	V
t _{rr}	ReverseRecovery Time	$I_F = 27A$, $dI_{SD}/dt = 100A/\mu s$,	-	205	238	ns
Q _{rr}	ReverseRecovery Charge	V _{DD} =200V	-	1.8	2.3	nC

Notes

4: The maximum value is specified by design at $T_J = 150$ °C. Product is not tested to this condition in production.



Typical Characteristics

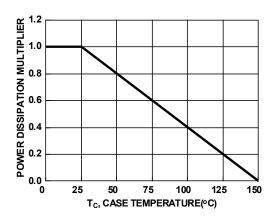
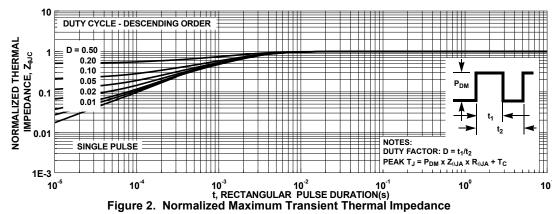


Figure 1. Normalized Power Dissipation vs. Case **Temperature**





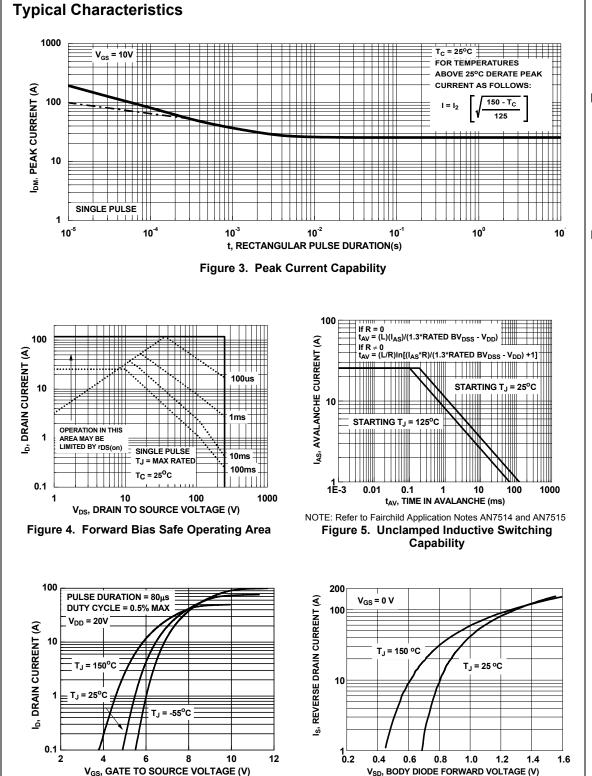


Figure 6. Transfer Characteristics

Figure 7. Forward Diode Characteristics



Typical Characteristics

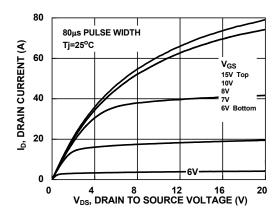


Figure 8. Saturation Characteristics

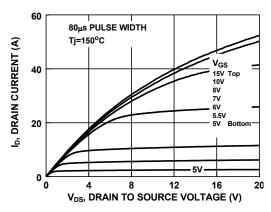


Figure 9. Saturation Characteristics

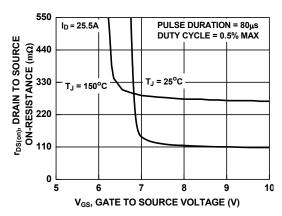


Figure 10. R_{DSON} vs. Gate Voltage

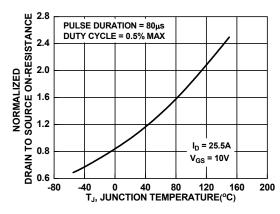


Figure 11. Normalized R_{DSON} vs. Junction Temperature

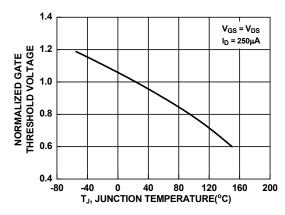


Figure 12. Normalized Gate Threshold Voltage vs. Temperature

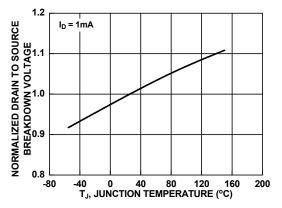
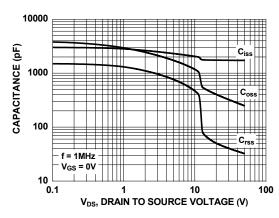
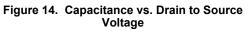


Figure 13. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature



Typical Characteristics





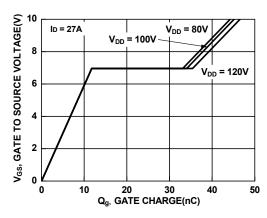


Figure 15. Gate Charge vs. Gate to Source Voltage



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Datasheet of FQI27N25TU_F085 - MOSFET N-CH 250V 25.5A I2PAK

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